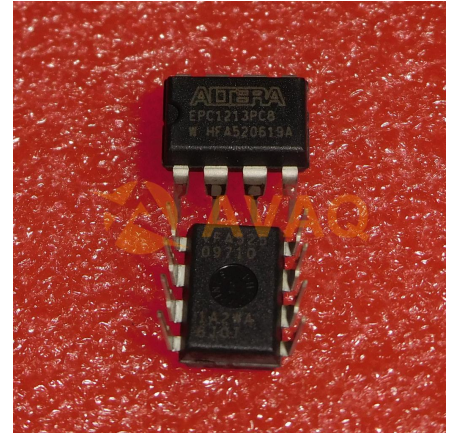


Configuration SRAM for FBGA

Manufacturer:	Intel Corp
Package/Case:	DIP8
Product Type:	Programmable Logic ICs
Lifecycle:	Obsolete



Images are for reference only

[Inquiry](#)

General Description

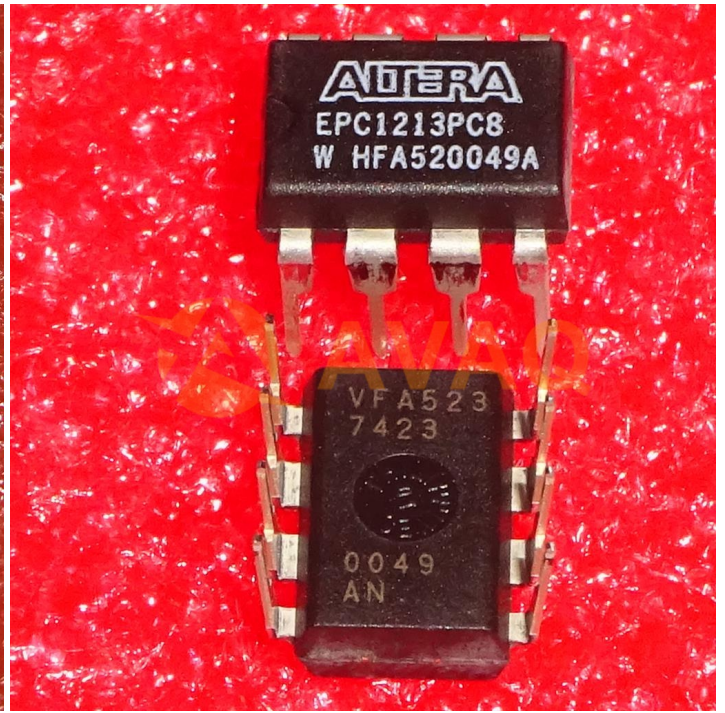
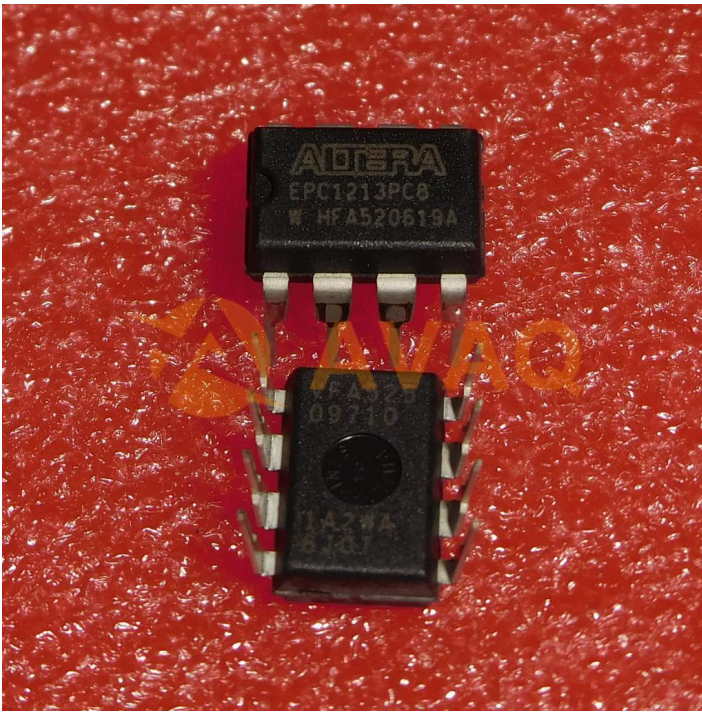
EPC1213PC8 refers to an integrated circuit (IC) chip from the Enhanced Product (EPC) family of power management devices designed and manufactured by Efficient Power Conversion Corporation (EPC).

Key Features

- High-frequency operation up to 5 MHz
- Low on-resistance of 12mΩ
- Low capacitance of 1020 pF
- Small package size (5mm x 6mm x 0.8mm)
- High efficiency and reliability

Application

- Wireless power transfer
- LiDAR (Light Detection and Ranging)
- DC-DC converters
- Motor drives
- LED lighting



Recommended For You

EPMB256AQC208-10N

Intel Corp

QFP208

EPCQ32AS18N

Intel Corp

SOP8

EPCQ32S18N

Intel Corp

SOP8

EPCQ64AS116N

Intel Corp

SOP16

EPCQ16S18N

Intel Corp

SOP8

EPC2T132

Intel Corp

QFP

EPM7128STC100-15N

Intel Corp

QFP100

EP1C6Q240I7N

Intel Corp

QFP240

EPCQ128S116N

Intel Corp

SOP16

EPM7128SLC84-15N

Intel Corp

PLCC

EP1K30TC144-3N

Intel Corp

QFP

EPCS1S18

Intel Corp

SOP-8

EPC1PI8N

Intel Corp

DIP8

EPC2LI20N

Intel Corp

PLCC

EPF10K50EFC484-2

Intel Corp

BGA